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John Stattler

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Steven Teig, et al.

Serial No.:

Not Yet Assigned

Filed:

Herewith

For:

Simulating Diagonal Wiring Directions

Using Manhattan Directional Wires (As

Amended)

PRELIMINARY AMENDMENT

Box PATENT APPLICATION Assistant Commissioner of Patents and Trademarks Washington, D.C. 20231

Sir:

This Preliminary Amendments is concurrently filed with the above-entitled application, which is a continuation application of a presently pending application Ser. No. 09/681,776, entitled "Diagonal Wiring Architecture For Integrated Circuit", filed on June 3, 2001, which is a continuation application of a presently pending application Ser. No. 09/733,104, entitled "Multi-Directional Wiring On A Single Metal Layer," filed on